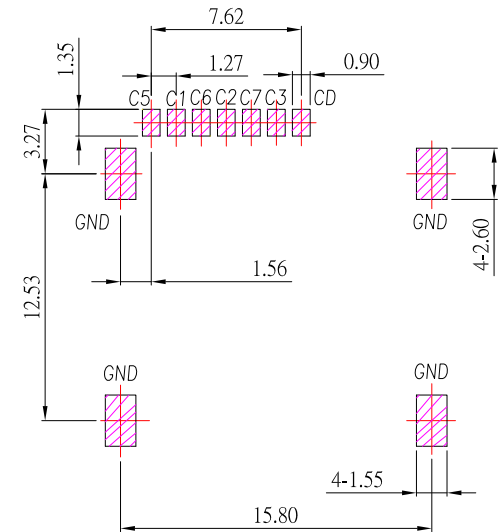
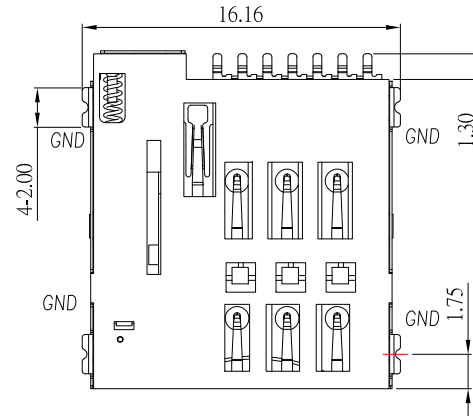
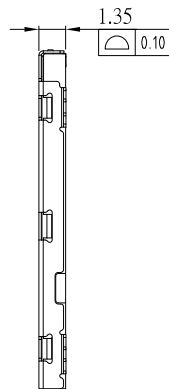
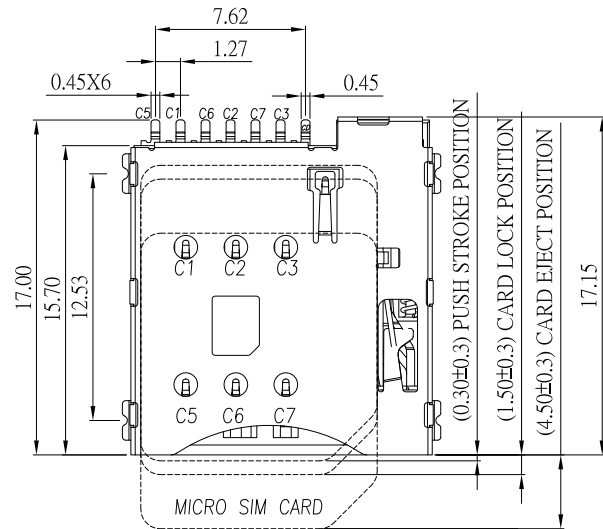
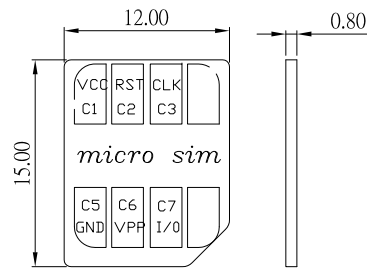
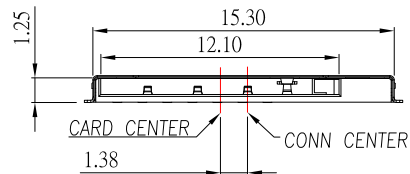
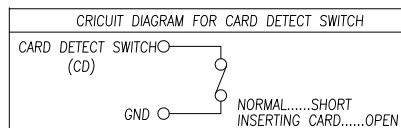




PCB LAYOUT



SIM pin Assignment	
PIN#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O



Material:

- 1.Housing: LCP
- 2.Contact: Copper Alloy
- 3.Shell: Stainless Steel

Finish:

- 1.Contact: Plated Gold in Mating Area ;
Gold Plated on Solder Balls ;
Nickel under plated overall
- 2.Shell: Nickel under Plated surface layer



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CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS
OTHERWISE STATED :

Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3

3RD.
ANGEL'S



UNITS

MM

DRAWN BY: Jack Lu
CHECKED BY: Jacky Chen
APPROVED BY: Tony Kao

DATE: 09/28/18
DATE: 09/28/18
DATE: 09/28/18

MAT'L
FINISH
SCALE
SHEET NO.

1 : 1
1 of 1

TITLE
MODLE
DWG NO.
PART NO.

CONNECTOR
MICRO SIM PUSH. 7PIN H1.35
MSIM-135A-01BR-S304
MSIM-135A-01BR-S304

SIZE
A4
VER
R

ITEM NO. DESCRIPTION DRAWN DATE